

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hyung Taek LIM	02/18/2013
RECEIVING PARTY DATA	
Name:	Doosan Infracore Co., Ltd.
Street Address:	7-11, Hwasu-dong, Dong-gu
City:	Incheon
State/Country:	REPUBLIC OF KOREA
Postal Code:	401-020
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13817857
CORRESPONDENCE DATA	
Fax Number:	6123343312
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Email:	tsorbel@wck.com
Correspondent Name:	John D. Veldhuis-Kroeze
Address Line 1:	900 Second Avenue South, Suite 1400
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402
ATTORNEY DOCKET NUMBER:	D297.12-0054/JVK
NAME OF SUBMITTER:	Theresa R. Sorbel
Total Attachments: 1 source=2013-02-22Assignment#page1.tif	

OP \$40.00 13817857

ASSIGNMENT

FOR PRIORITY APPLICATION ENTERING UNITED STATES

WHEREAS, I, LIM, Hyung Taek (hereinafter referred to as ASSIGNOR), am the sole inventor of an invention described in:

- Korean Patent Application No. 10-2010-0081074, filed on August 20, 2010;
- International application for Letters Patent filed pursuant to the Patent Cooperation Treaty and designating the United States, and being identified by Application No. PCT/KR2011/005869, filed on August 11, 2011;
- any United States Patent Application claiming priority from the above-identified Korean and/or International patent application, the United States patent application being identifiable in the United States Patent and Trademark Office by Application No. 13/817,857, filed February 20, 2013;

WHEREAS, DOOSAN INFRACORE CO., LTD. (hereinafter referred to as ASSIGNEE), a Korean Limited liability company organized and existing under the laws of the Republic of Korea, and having a place of business at 7-11 Hwasu-don, Dong-gu, Incheon 401-020 Republic of Korea, is desirous of acquiring the entire right, title and interest in and to the invention, the application and any and all Letters Patent(s) or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, I transfer to Assignee, its successors and assigns, my entire right, title and interest in and to the invention, the above-identified application, all inventions and improvements which are disclosed in the patent applications, all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent(s) which have been or shall be filed in the United States on any of said inventions and/or improvements, all rights of priority resulting from the filing of the above-identified patent application(s), and all Letters Patent or similar legal protection issuing thereon; and I authorize the Director of the United States Patent and Trademark Office to issue the Letters Patent or similar legal protection to the Assignee.

I authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and serial number of the application when ascertained.

I authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all countries.

I represent to the Assignee, its successors and assigns, that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I, my executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.

LIM, Hyung Taek

Signature of Inventor

Date : Feb. 18, 2013

LIM, Hyung Taek
Printed Name of Inventor

Residence of Inventor:

202-1201 Hyundai I-Park Apt. Boieong-dong

Giheung-gu Yongin Si

Gyeonggi-Do 446-567 Republic of Korea

[Signature]

Signature of Witness

Date : Feb. 18, 2013

PARK, Shin Young
Printed Name of Witness

Residence of Witness:

5th Fl. Gusegun Bldg. 7 Chungieongro

Seodaemun-gu, Seoul 120-013

Republic of Korea

-1 of 1-